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# **DATA SHEET**

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

01005

NPO/X5R/X7R

4 V TO 16 V

0.5 pF to 220 nF

RoHS compliant & Halogen Free



YAGEO Phícomp



#### SCOPE

This specification describes 01005 NP0/X5R series chip capacitors with lead-free terminations.

#### **APPLICATIONS**

- Mobile
- Module

#### **FEATURES**

- Supplied in tape on reel
- Nickel-barrier end termination
- RoHS compliant
- Halogen Free compliant

# ORDERING INFORMATION-GLOBAL PART NUMBER, PHYCOMP

#### CTC & 12NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

#### YAGEO BRAND ordering code

#### **GLOBAL PART NUMBER (PREFERRED)**

<u>xxxx x x xxx x</u> B <u>x xxx</u>

(1) (2) (3) (4) (5) (6) (7)

# (I) SIZE - INCH BASED (METRIC)

0100(0402)

#### (2) TOLERANCE

 $B = \pm 0.1 pF$ 

 $C = \pm 0.25 pF$ 

 $D = \pm 0.5 pF$ 

 $| = \pm 5\%$ 

 $K = \pm 10\%$ 

 $M = \pm 20\%$ 

#### (3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

#### (4) TC MATERIAL

NPO

X5R

X7R

#### (5) RATED VOLTAGE

 $4 = 4 \ \lor$ 

5 = 6.3 V

6 = 10 V

7 = 16 V

#### (6) PROCESS

N = NP0

B = Class 2 MLCC

#### (7) CAPACITANCE VALUE

2 significant digits+number of zeros

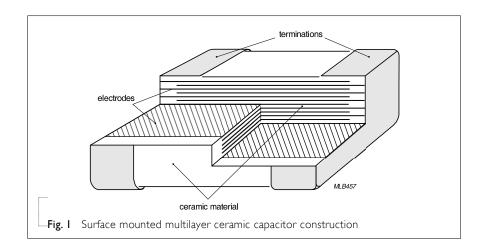
The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example:  $121 = 12 \times 10^{1} = 120 \text{ pF}$ 

# CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

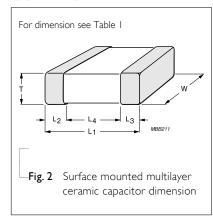


## **DIMENSION**

**Table I** For outlines see fig. 2

TVDE	(	<b>NA</b> / ()	T ()	L <sub>2</sub> / L <sub>3</sub>	L <sub>4</sub> (mm)	
TYPE	L <sub>I</sub> (mm)	W (mm)	T (mm)	min.	max.	min.
01005	0.4 ±0.02	0.2 ±0.02	0.2 ±0.02	0.07	0.14	0.13

#### **OUTLINES**





#### CAPACITANCE RANGE & THICKNESS

**Surface-Mount Ceramic Multilayer Capacitors** 

Table 2 01			_					
CAP.	NP0	CAP.	X5R			CAP.	X7R	
	10V / 16 V		4V	6.3V	10V		6.3V / 10V	16V
0.5 pF	0.2±0.02	100 pF	0.2±0.02	0.2±0.02	0.2±0.02	100 pF	0.2±0.02	0.2±0.02
0.6 pF	0.2±0.02	150 pF	0.2±0.02	0.2±0.02	0.2±0.02	150 pF	0.2±0.02	0.2±0.02
0.7 pF	0.2±0.02	220 pF	0.2±0.02	0.2±0.02	0.2±0.02	220 pF	0.2±0.02	0.2±0.02
0.75 pF	0.2±0.02	330 pF	0.2±0.02	0.2±0.02	0.2±0.02	330 pF	0.2±0.02	0.2±0.02
0.8 pF	0.2±0.02	470 pF	0.2±0.02	0.2±0.02	0.2±0.02	470 pF	0.2±0.02	0.2±0.02
0.9 pF	0.2±0.02	680 pF	0.2±0.02	0.2±0.02	0.2±0.02	680 pF	0.2±0.02	0.2±0.02
1.0 pF	0.2±0.02	1 000 pF	0.2±0.02	0.2±0.02	0.2±0.02	1 000 pF	0.2±0.02	0.2±0.02
1.2 pF	0.2±0.02	2.2 nF	0.2±0.02	0.2±0.02	0.2±0.02	2.2 nF		
1.5 pF	0.2±0.02	4.7 nF	0.2±0.02	0.2±0.02	0.2±0.02	4.7 nF		
1.8 pF	0.2±0.02	10 nF	0.2±0.02	0.2±0.02	0.2±0.02	10 nF		
2.2 pF	0.2±0.02	22nF	0.2±0.02	0.2±0.02		22nF		
2.7 pF	0.2±0.02	47 nF	0.2±0.02	0.2±0.02		47 nF		
3.3 pF	0.2±0.02	100 nF	0.2±0.02	0.2±0.02		100 nF		
3.9 pF	0.2±0.02	220 nF	0.2±0.02	0.2±0.02		220 nF		
4.7 pF	0.2±0.02	Tape width	<u>-</u>	8 mm		Tape width	8 mr	n
5.6 pF	0.2±0.02							
6.8 pF	0.2±0.02							
8.2 pF	0.2±0.02							
10 pF	0.2±0.02							



12 pF

15 pF

18 pF 22 pF

27 pF

33 pF

39 pF

47 pF

56 pF

68 pF

82 pF

100 pF

Tape width

0.2±0.02

0.2±0.02 0.2±0.02

0.2±0.02

0.2±0.02

0.2±0.02

0.2±0.02

0.2±0.02

0.2±0.02

0.2±0.02

 $0.2 \pm 0.02$ 

0.2±0.02

8 mm

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#### THICKNESS CLASSES AND PACKING QUANTITY Table 2

Table 3							
SIZE	SIZE THICKNESS	THICKNESS TAPE WIDTH —		1 / 7 INCH	Ø330 MM	1 / 13 INCH	OUANTITY
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper/PE	Blister	Paper/	Blister	PER BULK CASE
01005	0.2 ±0.02 mm	8 mm	20,000				

#### **ELECTRICAL CHARACTERISTICS**

#### NP0/X5R DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

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DESCRIPT	ION	VALUE
Capacitano	e range	0.5 pF to 220 nF
Capacitano	e tolerance	
	C< 10 pF	±0.1pF, ±0.25pF, ±0.5pF
NP0	C ≥ 10 pF	±5%, ±10%
X5R / X7	'R	±10%, ±20%
Dissipation	n factor (D.F.)	
NP0	C < 30 pF	≤ I / (400 + 20C)
	C ≥ 30 pF	≤ 0.1 %
X5R / X7R		≤ 10%
Insulation r	resistance after I minute at U <sub>r</sub> (DC)	$R_{ins} \ge 10~G\Omega$ or $R_{ins} \times C \ge 500\Omega \cdot F$ whichever is less $\times 5R/X7R > 10nF$ : $R_{ins} \times C \ge 50\Omega \cdot F$
	capacitance change as a function of temperature ure characteristic/coefficient):	NIIS X C ≥ 30022 · F
NP0		±30 ppm/°C
X5R / X7	rR.	±15%
Operating	temperature range:	
NP0		-55 °C to +125 °C
X5R		–55 °C to +85 °C
X7R		-55 °C to +125 °C

## SOLDERING RECOMMENDATION

YAGEO Phicomp

Table 5	
SOLDERING METHOD	SIZE 01005
Reflow	Reflow only
Reflow/Wave	

# TESTS AND REQUIREMENTS

**Table 6** Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage	
Visual Inspection and Dimension Check		4.4	Any applicable method using × 10 magnification	In accordance with specification	
Capacitance		4.5.1	Class I: $f = I \text{ MHz for C} \le I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for C} > I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$	Within specified tolerance	
			Class 2:		
			$C \le I$ nF f = I KHz, measuring at voltage I Vrms at 20 °C		
			C > I nF $f = I$ KHz, rated voltage $\leq$ 6.3 V, measuring at voltage 0.5 Vrms at 20 °C $f = I$ KHz, rated voltage > I0 V, measuring at voltage I Vrms at 20 °C		
Dissipation Factor (D.F.)		4.5.2	Class I: $f = I \text{ MHz for } C \leq I \text{ nF , measuring at voltage } I \text{ V}_{ms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for } C > I \text{ nF, measuring at voltage } I \text{ V}_{ms} \text{ at } 20 \text{ °C}$	In accordance with specification	
			Class 2: $C \le I \text{ nF}$ f = I  KHz, measuring at voltage  I  Vrms at  20  °C		
			C > I nF $f = I$ KHz, rated voltage $\leq 6.3$ V, measuring at voltage 0.5 Vrms at 20 °C f = I KHz, rated voltage > I0 V,		
			measuring at voltage   Vrms at 20 °C		
Insulation Resistance		4.5.3	At Ur (DC) for I minute	In accordance with specification	

TEST	TEST METH	HOD	PROCED	URE	REQUIREMENTS	
Temperature coefficient		4.6	Capacitance shall be measured by the steps shown in the following table.  The capacitance change should be measured after 5 min at each specified temperature stage.		ΔC/C Class I (NP0):	
					±30ppm	
			Step	Temperature(°C)	Class 2: (X7R/X5R): ±15%	
			a	25±2	113/6	
			Ь	Lower temperature±3°C	In case of applying voltage, the capacitance	
			С	25±2	change should be measured after I more min. with applying	
		voltage in equilibration of each temp. stage.				
			е	25±2	CC0100MRX5R4(5)BB104(224):	
			(I) Class		0.2V±0.1Vrms	
				ure Coefficient shall be calculated from la as below		
			Temp, Coefficient = $\frac{C2 - C1}{C1 \times \Delta T} \times 10^6$ [ppm/°C]  C1: Capacitance at step c  C2: Capacitance at 125°C			
			ΔT: 100°C	C(=125°C-25°C)		
				Voltage: 0.5 to 5 Vrms		
			(2) Class II  Capacitance Change shall be calculated from the formula as below			
			$\Delta C = \frac{C2}{C}$	<u>-CI</u> × 100%		
			C1: Capac	itance at step c		
			C2: Capac	itance at step b or d		
Adhesion	IEC 60384- 21/22	4.7		oplied for 10 seconds to the line joining nations and in a plane parallel to the	Force size 01005 : IN	
Bending Strength		4.8	Mounting paragraph	in accordance with IEC 60384-22 4.3	No visible damage	
			Condition radius jig 5	s: bending I mm at a rate of I mm/s, i mm	ΔC/C Class I (NP0):	

within  $\pm 1\%$  or 0.5 pF, whichever is greater

Class2 (X5R/X7R):

±10%

NP0/X5RX7R

6.3V to 16V

TEST	TEST METHO	OD	PROCEDURE	REQUIREMENTS
Resistance to Soldering Heat	4	4.9	Precondition: I50 +0/-10 °C for I hour, then keep for 24 ±1 hours at room	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
			temperature  Preheating: 120 °C to 150 °C for I minute and 170 °C to 200 °C for I minute.  Solder bath temperature: 260 ±5 °C  Dipping time: 10 ±0.5 seconds  Recovery time: 24 ±2 hours	ΔC/C Class I (NP0): within ±0.5% or 0.5 pF, whichever is greater  Class2 (X5R/X7R): ±10%  D.F. within initial specified value  R <sub>ins</sub> within initial specified value
Solderability		4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination
			Test conditions for leadfree containing solder alloy  Temperature: 245 ±5 °C  Dipping time: 3 ±0.3 seconds  Depth of immersion: 10 mm	
Rapid Change of	IEC 60384-	4.11	Preconditioning; I50 +0/–I0 °C for I hour, then keep for	No visual damage
Temperature			24 ±1 hours at room temperature  5 cycles with following detail:  30 minutes at lower category temperature  30 minutes at upper category temperature	$\Delta$ C/C Class I (NP0): within $\pm 2.5\%$ or 0.25 pF, whichever is greater Class2 (X5R/X7R): $\pm 15\%$
			Recovery time 24 ±2 hours	D.F. meet initial specified value R <sub>ins</sub> meet initial specified value

NP0/X5RX7R

6.3V to 16V

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Damp Heat	with Ur load	4.I3	<ol> <li>Preconditioning, class 2 only:         <ul> <li>150 +0/-10 °C /I hour, then keep for</li> <li>24 ±I hour at room temp</li> </ul> </li> <li>Initial measure:         <ul> <li>Spec: refer initial spec C, D, IR</li> </ul> </li> <li>Damp heat test:         <ul> <li>500 ±12 hours at 40 ±2 °C;</li> </ul> </li> </ol>	REQUIREMENTS  No visual damage after recovery  Class I (NP0): $\Delta C/C$ within $\pm 7.5\%$ or $0.75$ pF, whichever is greater D.F. $\leq 2 \times \text{specified value}$ I.R.
			90 to 95% R.H; I.O Ur applied.  4. Recovery: Class I: 6 to 24 hours Class 2: 24 ±2 hours  5. Final measure: C, D, IR	$\geq$ 2,500 M $\Omega$ or R <sub>ins</sub> $\times$ Cr $\geq$ 25 $\Omega$ · F whichever is less Class2 (X5R/X7R): C $\leq$ InF
			P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met.	$\Delta C/C$ ±15% D.F. ≤10% I.R. ≥500 M $\Omega$ 10nF ≥ C > InF $\Delta C/C$ ±20% D.F. ≤10% I.R.
				$\geq 500 \text{ M}\Omega$ C > 10nF $\Delta$ C/C $\pm 25\%$ D.F. $\leq 20\%$ I.R. $R_{\text{ins}} \times Cr \geq 5\Omega \cdot F$

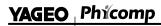
Surface-Mount Ceramic Multilayer Capacitors

01005

NP0/X5RX7R

6.3V to 16V

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Endurance	IEC 60384- 4.14 21/22		No visual damage  Class I (NP0): $\Delta C/C$ within $\pm 3\%$ or 0.3 pF, whichever is greater D.F. $\leq 2 \times \text{specified value}$
Voltage Proof	IEC 60384-1 4.5.	4 Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur	No breakdown or flashover
		Charge/Discharge current is less than 50 mA	



Product specification 11 Surface-Mount Ceramic Multilayer Capacitors 01005

NP0/X5RX7R

6.3V to 16V

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## REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 9	Jan. 17, 2017		- Test condition updated
Version 8	Jan. 12, 2016		- Capacitance range & thickness update
Version 7	Oct. 31, 2015		- Capacitance range & thickness update
Version 6	Jun. 29, 2015		- Test procedures and requirements
Version 5	Jun. 06, 2013		- Test procedures and requirements
Version 4	Mar. 27, 2013		- Change Tolerance
Version 3	Jan. 15, 2013		- Change Range
Version 2	Oct. 23, 2012		- Change Range
Version I	July 03, 2012		- Change Range
Version 0	Apr 16, 2012	-	- New

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2225J2500824KXT CCR07CG103KM CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D

CGA2B2C0G1H070D CGA2B2C0G1H151J CGA2B2C0G1H1R5C CGA2B2C0G1H2R2C CGA2B2C0G1H3R3C CGA2B2C0G1H680J

CGA4J2X7R2A104K